

Application Number 	Application No.	Applicant(s)
	10/809,420	WANG, ZHONGZE

TERMINAL DISCLAIMER filed 11/10/04 has been:	<input checked="" type="checkbox"/> APPROVED	<input type="checkbox"/> DISAPPROVED
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 10/809,420
Filing Date March 26, 2004
Inventor Zhongze Wang
Assignee..... Micron Technology, Inc.
Group Art Unit..... 2812
Examiner Jennifer M. Kennedy
Attorney's Docket No. MI22-2534
Customer No. 021567
Title: Silicon-on-Insulator Comprising Integrated Circuitry and Methods of
Forming Silicon-on-Insulator Circuitry

TERMINAL DISCLAIMER

I, Mark S. Matkin, residing at Spokane, Washington, represent that I am the attorney of record for Micron Technology, Inc., a corporation of the state of Delaware. Micron Technology, Inc. is the owner of all right, title and interest of this U.S. Patent Application Serial No. 10/809,420, filed on March 26, 2004, as evidenced by an assignment recorded on January 16, 2002 at Reel 012517 in Frames 0450-0453 in the U.S. Patent and Trademark Office.

Micron Technology, Inc. is also the owner of all rights, title and interest in co-pending U.S. Patent Application Serial No. 10/749,659, as evidenced by an assignment recorded on January 16, 2002 at Reel 012517 in Frames 0450-0453 in the U.S. Patent and Trademark Office.

The evidentiary documents have been reviewed, and I certify that, to
the best of assignee's knowledge and belief, title is in the assignee seeking
to take this action.

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Micron Technology, Inc. hereby disclaims the terminal part of any future patent granted on this U.S. Patent Application Serial No. 10/809,420 which extends beyond the expiration date of any future patent granted on co-pending U.S. Patent Application Serial No. 10/749,659, and further hereby agrees that any future patent so granted on this U.S. Patent Application Serial No. 10/809,420 shall be enforceable only for and during such period that the legal title on any future patent granted on co-pending U.S. Patent Application Serial No. 10/749,659 shall be the same as the legal title to any patent issued from U.S. Patent Application Serial No. 10/809,420. This agreement is to run with any patent granted on the application and is to be binding upon the grantees of such patent and its successors or assigns.

Micron Technology, Inc. does not disclaim any terminal part of any patent granted on this 10/809,420 application prior to the expiration date of the full statutory term of any patent granted on co-pending U.S. Patent Application Serial No. 10/749,659 in the event that it later: expires for failure to pay a maintenance fee, is held unenforceable, is found invalid by a court of competent jurisdiction, is statutorily disclaimed in whole or terminally disclaimed under 37 C.F.R. § 1.321(a), has all claims canceled by a reexamination certificate, is reissued in any matter or is otherwise terminated prior to expiration of its full statutory term as presently shortened by any terminal disclaimer, except for the separation of legal title stated above.

The fee required by 37 C.F.R. § 1.20(d) is submitted herewith. The Commissioner is hereby authorized to charge payment of any additional fees or credit overpayments to Deposit Account No. 23-0925.

The undersigned, Mark S. Matkin, hereby indicates that he is authorized to sign this document on behalf of the assignee, Micron Technology, Inc.

Respectfully submitted,

Dated:

11-9-04

By 
Mark S. Matkin
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